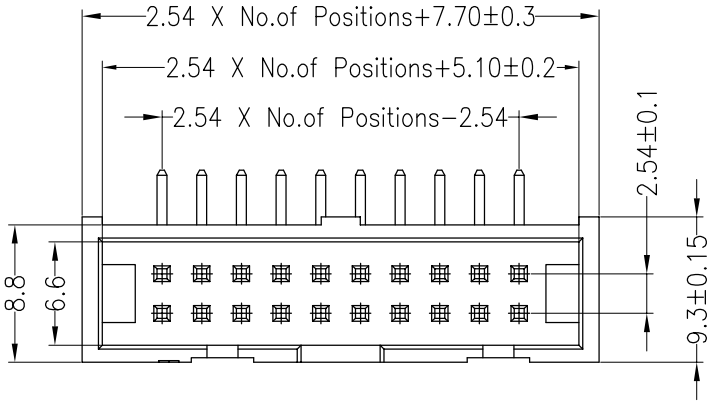
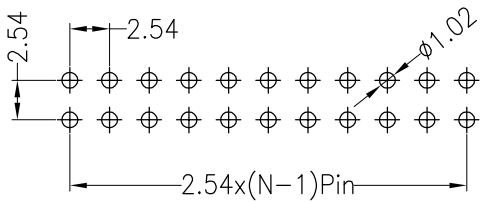
HSF RoHS

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PBT
Max.Processing Temp: 180°C for 30−60 seconds
(230°C for 10 seconds)



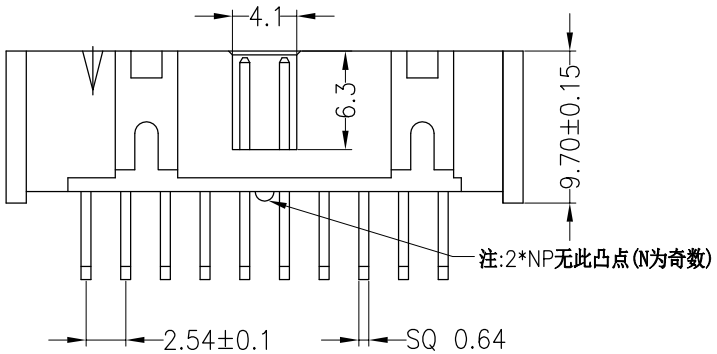

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

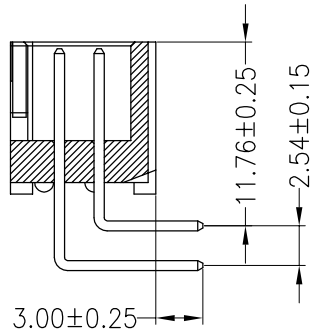



## *Ordering Information*

3214 XX R XX X B K00 X 0X

- XX: No.of Pins 8−−64
- XX: Contact Plating
  G0:Gold Flash
  G1:1U" Gold
  G2:1.5U" Gold
  G3:2U" Gold
  G4:3U" Gold
  G5:5U" Gold
  S0:Gold Flash/Tin
  SN:Tin
- X: Insulator Material Option
  A=BK−PBT
  C=BK−PA6T
  D=BK−PA46
  E=BK−PA9T
  F=BK−LCP
- X: Packing
  0=PE Bag
  A=Tray
  T=Tube
  P=Tube+Cap




| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| A0 | 2016.01.08 | NEW DRAWING | |

| OPERATION | | DRAW | Liu Miao | 16.01.18 | SCALE | FIT |
|---|---|---|---|---|---|---|
| X.X | ±0.30 | | | | UNIT | mm |
| X.XX | ±0.20 | CHECK | | | SIZE | A4 |
| X.XXX | ±0.10 | | | | SHEET | 1/1 |
| Angle | ±3° | APPROVE | | | PROJ. | |
| DIM | TOL | | | | | |

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

| PART NO. | 3214XXRXXXBK00X0X |
|---|---|
| TITLE: | 2.54DC3−NP H9.7 90° 无钩型开天窗 |